TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

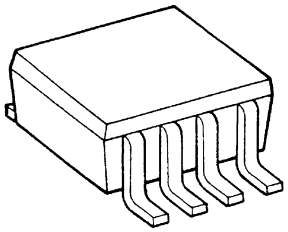
TC7WG125FU,TC7WG125FK

Dual Bus Buffer with 3-STATE Output

Features

- High output current : ±8 mA (min) at V_{CC} = 3V
- Super high speed operation : t_{pd} = 2.5 ns (typ.) at V_{CC} = 3.3V,15pF
- Operating voltage range : V_{CC} = 0.9 to 3.6 V
- 5.5-V tolerant inputs
- 3.6-V power down protection outputs

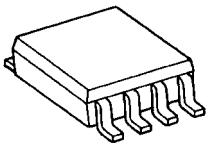
TC7WG125FU



SSOP8-P-0.65

(SM8)

TC7WG125FK

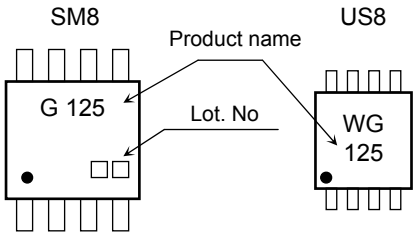


SSOP8-P-0.50A

(US8)

Weight
SSOP8-P-0.65 : 0.02 g (typ.)
SSOP8-P-0.50A : 0.01 g (typ.)

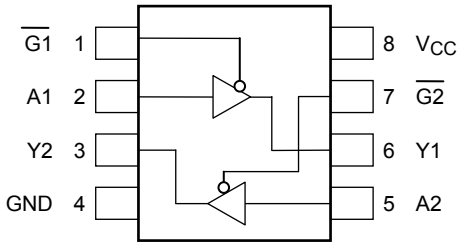
Marking



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	−0.5 to 4.6	V
DC input voltage	V_{IN}	−0.5 to 7.0	V
DC output voltage	V_{OUT}	−0.5 to 4.6 (Note 1)	V
		−0.5 to V_{CC} + 0.5 (Note 2)	
Input diode current	I_{IK}	−20	mA
Output diode current	I_{OK}	−20 (Note 3)	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC} / GND current	I_{CC}	±100	mA
Power dissipation	P_D	300 (SM8) 200 (US8)	mW
Storage temperature	T_{stg}	−65 to 150	°C

Pin Assignment (top view)



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: V_{CC} = 0V

Note 2: High or Low state. Do not exceed I_{OUT} of absolute maximum ratings.

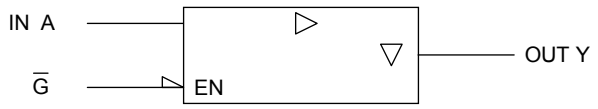
Note 3: V_{OUT} < GND

Truth Table

$\overline{G}$	A	Y
H	X	Z
L	L	L
L	H	H

X: Don't Care
Z: High impedance

IEC Logic Symbol



Operating Ranges

Characteristics	Symbol	Rating		Unit
Supply voltage	V_{CC}	0.9 to 3.6		V
Input voltage	V_{IN}	0 to 5.5		V
Output voltage	V_{OUT}	0 to 3.6	(Note 4)	V
		0 to V_{CC}	(Note 5)	
Output current	I_{OH}/I_{OL}	±8.0	(Note 6)	mA
		±4.0	(Note 7)	
		±3.0	(Note 8)	
		±1.7	(Note 9)	
		±0.3	(Note 10)	
		±0.02	(Note 11)	
Operating temperature	T_{opr}	−40 to 85		°C
Input rise and fall time	dt/dv	0 to 10	(Note 12)	ns/V

Note 4: V_{CC} = 0V
Note 5: High or Low state
Note 6: V_{CC} = 3.0 to3.6 V
Note 7: V_{CC} = 2.3 to 2.7 V
Note 8: V_{CC} = 1.65 to 1.95 V
Note 9: V_{CC} = 1.4 to 1.6 V
Note 10: V_{CC} = 1.1 to 1.3 V
Note 11: V_{CC} = 0.9 V
Note 12: V_{IN} = 0.8 to 2.0 V, V_{CC} = 3.0 V

Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test Condition		V_{CC} (V)	Ta = 25°C			Ta = −40 to 85°C		Unit
						Min	Typ.	Max	Min	Max	
Input voltage	High level	V_{IH}	—		0.9	V_{CC}	—	—	V_{CC}	—	V
					1.1 to 1.3	V_{CC} × 0.7	—	—	V_{CC} × 0.7	—	
					1.4 to 1.6	V_{CC} × 0.65	—	—	V_{CC} × 0.65	—	
					1.65 to 1.95	V_{CC} × 0.65	—	—	V_{CC} × 0.65	—	
					2.3 to 2.7	1.7	—	—	1.7	—	
					3.0 to 3.6	2.0	—	—	2.0	—	
	Low level	V_{IL}	—		0.9	—	—	GND	—	GND	
					1.1 to 1.3	—	—	V_{CC} × 0.3	—	V_{CC} × 0.3	
					1.4 to 1.6	—	—	V_{CC} × 0.35	—	V_{CC} × 0.35	
					1.65 to 1.95	—	—	V_{CC} × 0.35	—	V_{CC} × 0.35	
					2.3 to 2.7	—	—	0.7	—	0.7	
					3.0 to 3.6	—	—	0.8	—	0.8	
Output voltage	High level	V_{OH}	V_{IN} = V_{IL} or V_{IH}	I_{OH} = −0.02 mA	0.9	0.75	—	—	0.75	—	V
				I_{OH} = −0.3 mA	1.1 to 1.3	V_{CC} × 0.75	—	—	V_{CC} × 0.75	—	
				I_{OH} = −1.7 mA	1.4 to 1.6	V_{CC} × 0.75	—	—	V_{CC} × 0.75	—	
				I_{OH} = −3.0 mA	1.65 to 1.95	V_{CC} -0.45	—	—	V_{CC} -0.45	—	
				I_{OH} = −4.0 mA	2.3 to 2.7	2.0	—	—	2.0	—	
				I_{OH} = −8.0 mA	3.0 to 3.6	2.48	—	—	2.48	—	
	Low level	V_{OL}	V_{IN}= V_{IL}	I_{OL} = 0.02 mA	0.9	—	—	0.1	—	0.1	
				I_{OL} = 0.3 mA	1.1 to 1.3	—	—	V_{CC} × 0.25	—	V_{CC} × 0.25	
				I_{OL} = 1.7 mA	1.4 to 1.6	—	—	V_{CC} × 0.25	—	V_{CC} × 0.25	
				I_{OL} = 3.0 mA	1.65 to 1.95	—	—	0.45	—	0.45	
				I_{OL} = 4.0 mA	2.3 to 2.7	—	—	0.4	—	0.4	
				I_{OL} = 8.0 mA	3.0 to 3.6	—	—	0.4	—	0.4	
Input leakage current		I_{IN}	V_{IN} = 0 to 5.5V		0 to 3.6	—	—	±0.1	—	±1.0	μA
3-state output off-state current		I_{OZ}	V_{IN} = V_{IH} or V_{IL} V_{OUT} = 0 to 3.6V		0.9 to 3.6	—	—	1.0	—	10.0	μA
Power off leakage current		I_{OFF}	V_{IN} = 0 to 5.5V V_{OUT} = 0 to 3.6V		0.0	—	—	1.0	—	10.0	μA
Quiescent supply current		I_{CC}	V_{IN} = V_{CC} or GND		3.6	—	—	1.0	—	10.0	μA

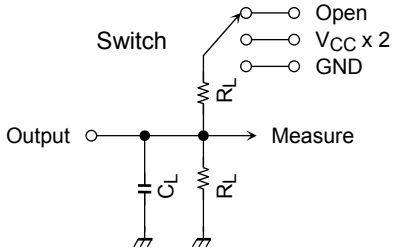
AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max	
Propagation delay time	t_{pLH} t_{pHL}	C_L = 10 pF, R_L = 1 MΩ	0.9	—	18.3	—	—	—	ns
			1.1 to 1.3	—	9.4	18.4	1.0	34.9	
			1.4 to 1.6	—	5.5	8.5	1.0	10.7	
			1.65 to 1.95	—	4.2	6.2	1.0	6.7	
			2.3 to 2.7	—	2.8	3.9	1.0	4.4	
			3.0 to 3.6	—	2.3	3.1	1.0	3.7	
		C_L = 15 pF, R_L = 1 MΩ	0.9	—	21.2	—	—	—	
			1.1 to 1.3	—	10.7	21.5	1.0	38.0	
			1.4 to 1.6	—	6.1	9.3	1.0	11.9	
			1.65 to 1.95	—	4.7	6.9	1.0	7.1	
			2.3 to 2.7	—	3.1	4.4	1.0	5.0	
			3.0 to 3.6	—	2.5	3.4	1.0	3.9	
		C_L = 30 pF, R_L = 1 MΩ	0.9	—	30.5	—	—	—	
			1.1 to 1.3	—	14.9	30.0	1.0	58.1	
			1.4 to 1.6	—	8.2	13.2	1.0	16.6	
			1.65 to 1.95	—	6.1	9.2	1.0	9.9	
			2.3 to 2.7	—	4.1	5.7	1.0	6.1	
			3.0 to 3.6	—	3.4	4.4	1.0	4.8	
Output enable time	t_{pZL} t_{pZH}	C_L = 10 pF, R_L = 100 kΩ	0.9	—	24.0	—	—	—	ns
		C_L = 10 pF, R_L = 5 kΩ	1.1 to 1.3	—	11.8	22.5	1.0	35.8	
			1.4 to 1.6	—	6.8	10.4	1.0	12.0	
			1.65 to 1.95	—	5.1	7.3	1.0	8.1	
			2.3 to 2.7	—	3.4	4.6	1.0	5.3	
			3.0 to 3.6	—	2.5	3.4	1.0	3.9	
		C_L = 15 pF, R_L = 100 kΩ	0.9	—	26.6	—	—	—	
		C_L = 15 pF, R_L = 5 kΩ	1.1 to 1.3	—	13.0	25.0	1.0	41.9	
			1.4 to 1.6	—	7.4	11.4	1.0	13.4	
			1.65 to 1.95	—	5.5	7.9	1.0	8.5	
			2.3 to 2.7	—	3.7	4.9	1.0	5.5	
			3.0 to 3.6	—	3.0	4.1	1.0	4.6	
		C_L = 30 pF, R_L = 100 kΩ	0.9	—	36.4	—	—	—	
		C_L = 30 pF, R_L = 5 kΩ	1.1 to 1.3	—	17.9	35.8	1.0	59.1	
			1.4 to 1.6	—	9.8	15.3	1.0	17.8	
			1.65 to 1.95	—	7.2	10.5	1.0	11.2	
			2.3 to 2.7	—	4.5	5.9	1.0	6.6	
			3.0 to 3.6	—	3.6	4.6	1.0	5.3	

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max	
Output disable time	t_{pLZ} t_{pHZ}	C_L = 10 pF, R_L = 100 kΩ	0.9	—	168.6	—	—	—	ns
		C_L = 10 pF, R_L = 5 kΩ	1.1 to 1.3	—	9.5	18.4	1.0	25.2	
			1.4 to 1.6	—	7.5	9.5	1.0	10.6	
			1.65 to 1.95	—	7.1	8.7	1.0	9.6	
			2.3 to 2.7	—	6.8	7.9	1.0	8.8	
			3.0 to 3.6	—	6.5	7.5	1.0	8.4	
		C_L = 15 pF, R_L = 100 kΩ	0.9	—	201.8	—	—	—	
		C_L = 15 pF, R_L = 5 kΩ	1.1 to 1.3	—	10.5	19.8	1.0	27.6	
			1.4 to 1.6	—	9.0	10.4	1.0	12.3	
			1.65 to 1.95	—	8.5	9.7	1.0	10.6	
			2.3 to 2.7	—	7.9	8.8	1.0	10.3	
			3.0 to 3.6	—	7.6	8.3	1.0	9.5	
		C_L = 30 pF, R_L = 100 kΩ	0.9	—	251.5	—	—	—	
		C_L = 30 pF, R_L = 5 kΩ	1.1 to 1.3	—	14.1	23.8	1.0	31.9	
			1.4 to 1.6	—	13.5	14.5	1.0	16.0	
			1.65 to 1.95	—	12.7	14.3	1.0	15.0	
			2.3 to 2.7	—	12.2	14.1	1.0	14.7	
			3.0 to 3.6	—	11.9	13.8	1.0	14.4	
Input capacitance	C_{IN}	—	3.6	—	3	—	—	—	pF
Power dissipation capacitance	C_{PD}	(Note 13)	0.9 to 3.6	—	10	—	—	—	pF

Note 13: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.
Average operating current can be obtained by the equation:
$I_{CC\ (opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$

AC Characteristics Measurement Circuit



Characteristics	Switch
t_{pLH}, t_{pHL}	Open
t_{pLZ}, t_{pZL}	V_{CC} x 2
t_{pHZ}, t_{pZH}	GND

Figure1

AC Characteristics Measurement Waveforms

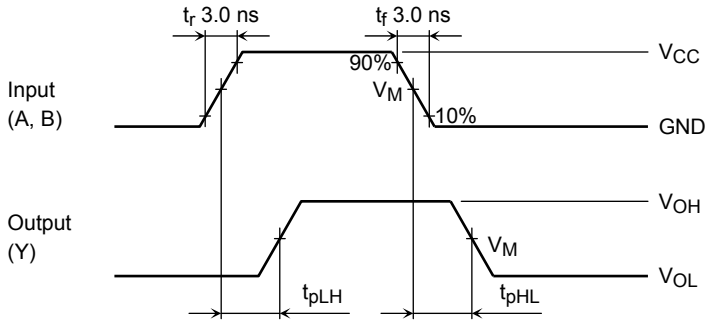


Figure2 t_{pLH}, t_{pHL}

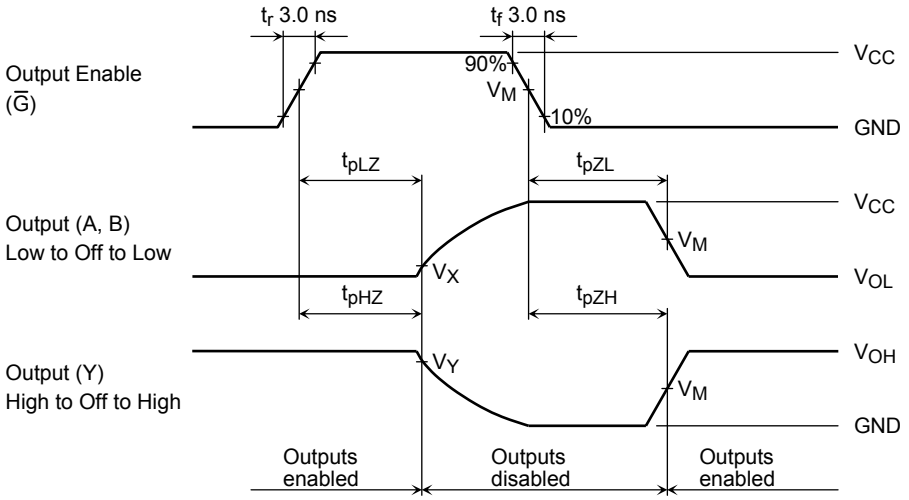
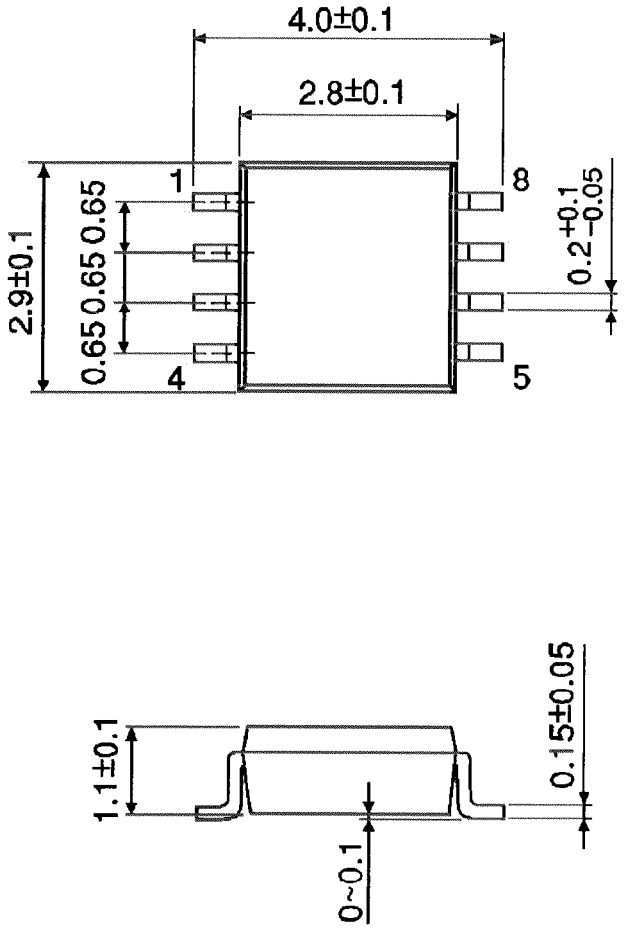


Figure3 t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}

SYMBOL	V_{CC}					
	3.3±0.3 V	2.5±0.2 V	1.8±0.15 V	1.5±0.1 V	1.2±0.1 V	0.9 V
V_M	V_{CC} / 2	V_{CC} / 2	V_{CC} / 2	V_{CC} / 2	V_{CC} / 2	V_{CC} / 2
V_X	V_{OL} + 0.3 V	V_{OL} + 0.15 V	V_{OL} + 0.15 V	V_{OL} + 0.1 V	V_{OL} + 0.1 V	V_{OL} + 0.1 V
V_Y	V_{OH} - 0.3 V	V_{OH} - 0.15 V	V_{OH} - 0.15 V	V_{OH} - 0.1 V	V_{OH} - 0.1 V	V_{OH} - 0.1 V

Package Dimensions

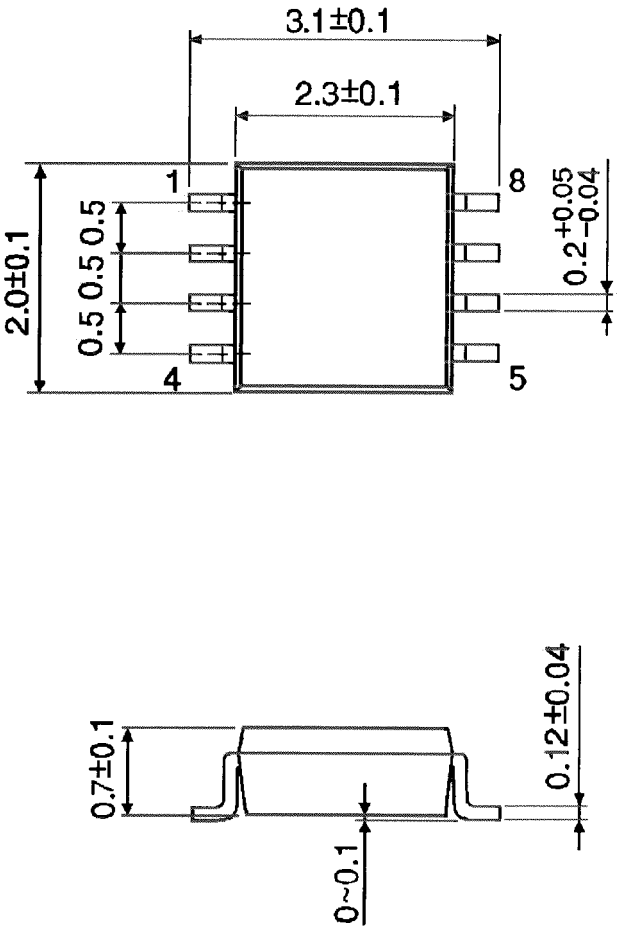
SSOP8-P-0.65 Unit : mm



Weight: 0.02 g (typ.)

Package Dimensions

SSOP8-P-0.50A Unit : mm



Weight: 0.01 g (typ.)

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